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Intel® SSD 730 Series (480GB, 2.5in SATA 6Gb/s, 20nm, MLC)

Recommended Customer Price

Specifications

Essentials

Performance

Reliability

Package Specifications

Advanced Technologies

Ordering / sSpecs /

Steppings

Download Drivers

Specifications	
- Essentials	
Capacity	480 GB
Status	Launched
Launch Date	Q1'14
Datasheet	Link
Product Brief	Link
Additional Information URL	Link
Lithography Type	20nm

N/A

- Performance	
Sequential Read (up to)	550 MB/s
Sequential Write (up to)	470 MB/s
Random Read (8GB Span) (up to)	89000 IOPS
Random Write (8GB Span) (up to)	74000 IOPS
Latency - Read	50 μs
Latency - Write	60 μs
Power - Active	5.5W
Power - Idle	1.5W

- Reliability	
Vibration - Operating	2.17 GRMS (5-700 Hz) Max
Vibration - Non-Operating	3.13 GRMS (5-800 Hz) Max
Shock (Operating and Non-Operating)	1,000 G (Max) at 0.5 msec
Operating Temperature Range	0°C to 70°C
Endurance Rating (Lifetime Writes)	70GB Writes/day
Mean Time Between Failures (MTBF)	2,000,000 Hours
Uncorrectable Bit Error Rate (UBER)	<1 sector per 10^17 bits read
Warranty Period	5 yrs

- Package Specifications	
Weight	72 grams ± 2 grams
Form Factor	2.5" 7mm
Interface	SATA 3.0 6Gb/S

Advanced Technologies	
No	
AES 256 bit	
No	
Yes	
No	
Yes	

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Intel® SSD 730 Series

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Refer to Datasheet for formal definitions of product properties and features.

"Announced" SKUs are not yet available. Please refer to the Launch Date for market availability.

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The Recommended Customer -unit purchase quantities, and are subject to change without notice. Taxes and shipping, etc. not included. Prices may vary for other package types and shipment quantities, and special promotional arrangements may apply. If sold in bulk, price represents individual unit. Listing of these RCP does not constitute a formal pricing offer from Intel. Please work with your appropriate Intel representative to obtain a formal price quotation.





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